## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## MJE13009

## Preferred Device

## SWITCHMODE ${ }^{\text {m }}$ Series <br> NPN Silicon Power

Transistors
The MJE13009 is designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. They are particularly suited for 115 and 220 V SWITCHMODE applications such as Switching Regulators, Inverters, Motor Controls, Solenoid/Relay drivers and Deflection circuits.

## Features

- $\mathrm{V}_{\mathrm{CEO}(\mathrm{sus})} 400 \mathrm{~V}$ and 300 V
- Reverse Bias SOA with Inductive Loads @ $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$
- Inductive Switching Matrix 3 to $12 \mathrm{Amp}, 25$ and $100^{\circ} \mathrm{Ct}_{\mathrm{c}} @ 8 \mathrm{~A}$, $100^{\circ} \mathrm{C}$ is 120 ns (Typ)
- 700 V Blocking Capability
- SOA and Switching Applications Information
- $\mathrm{Pb}-$ Free Package is Available*


## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-Emitter Voltage | $\mathrm{V}_{\text {CEO(sus) }}$ | 400 | Vdc |
| Collector-Emitter Voltage | $\mathrm{V}_{\text {CEV }}$ | 700 | Vdc |
| Emitter-Base Voltage | $\mathrm{V}_{\text {Ebo }}$ | 9 | Vdc |
| $\begin{array}{ll}\text { Collector Current } & \text { - Continuous } \\ & \text { - Peak (Note 1) }\end{array}$ | $\begin{aligned} & \mathrm{IC}_{\mathrm{C}} \\ & \mathrm{I}_{\mathrm{CM}} \end{aligned}$ | $\begin{aligned} & 12 \\ & 24 \end{aligned}$ | Adc |
| $\begin{array}{ll}\text { Base Current } & \text { - Continuous } \\ & \text { - Peak (Note 1) }\end{array}$ | $\begin{gathered} \mathrm{I}_{\mathrm{B}} \\ \mathrm{I}_{\mathrm{BM}} \end{gathered}$ | $\begin{gathered} 6 \\ 12 \end{gathered}$ | Adc |
| $\begin{aligned} \text { Emitter Current } & \text { - Continuous } \\ & \text { - Peak (Note 1) }\end{aligned}$ | $\begin{gathered} \mathrm{I}_{\mathrm{E}} \\ \mathrm{I}_{\mathrm{EM}} \end{gathered}$ | $\begin{aligned} & 18 \\ & 36 \end{aligned}$ | Adc |
| Total Device Dissipation @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ Derate above $25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | $\begin{gathered} 2 \\ 16 \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~W} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Total Device Dissipation @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ Derate above $25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | $\begin{aligned} & 100 \\ & 800 \end{aligned}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~W} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Operating and Storage Junction Temperature Range | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | $\begin{gathered} -65 \text { to } \\ +150 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\text {ӨJA }}$ | 62.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction-to-Case | $\mathrm{R}_{\theta \mathrm{JC}}$ | 1.25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Lead Temperature for Soldering <br> Purposes $1 / 8^{\prime \prime}$ from Case for 5 Seconds | $\mathrm{T}_{\mathrm{L}}$ | 275 | ${ }^{\circ} \mathrm{C}$ |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width $=5 \mathrm{~ms}$, Duty Cycle $\leq 10 \%$.
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## ON Semiconductor ${ }^{\circledR}$

http://onsemi.com

> 12 AMPERE NPN SILICON POWER TRANSISTOR 400 VOLTS - 100 WATTS


TO-220AB CASE 221A-09 STYLE 1

MARKING DIAGRAM


$$
\begin{aligned}
& \text { A } \quad=\text { Assembly Location } \\
& \text { Y } \quad=\text { Year } \\
& \text { WW }
\end{aligned}=\text { Work Week } \quad \begin{aligned}
& \text { G }
\end{aligned}
$$

## ORDERING INFORMATION

| Device | Package | Shipping |
| :--- | :---: | :---: |
| MJE13009 | TO-220 | 50 Units / Rail |
| MJE13009G | TO-220 <br> (Pb-Free) | 50 Units / Rail |

Preferred devices are recommended choices for future use and best overall value.

## ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 2) |  |  |  |  |  |
| Collector-Emitter Sustaining Voltage $\left(\mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=0\right)$ | $\mathrm{V}_{\text {CEO(sus) }}$ | 400 | - | - | Vdc |
| Collector Cutoff Current $\begin{aligned} & \left(\mathrm{V}_{\mathrm{CEV}}=\text { Rated Value, } \mathrm{V}_{\mathrm{BE} \text { (off })}=1.5 \mathrm{Vdc}\right) \\ & \left(\mathrm{V}_{\mathrm{CEV}}=\text { Rated Value, } \mathrm{V}_{\mathrm{BE}(\text { off })}=1.5 \mathrm{Vdc}, \mathrm{~T}_{\mathrm{C}}=100^{\circ} \mathrm{C}\right) \end{aligned}$ | $I_{\text {CEV }}$ | - | - | $\begin{aligned} & 1 \\ & 5 \end{aligned}$ | mAdc |
| Emitter Cutoff Current $\left(\mathrm{V}_{\mathrm{EB}}=9 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=0\right)$ | $l_{\text {ebo }}$ | - | - | 1 | mAdc |
| SECOND BREAKDOWN |  |  |  |  |  |
| Second Breakdown Collector Current with base forward biased Clamped Inductive SOA with Base Reverse Biased | $\mathrm{I}_{\mathrm{S} / \mathrm{b}}$ |  |  |  |  |

ON CHARACTERISTICS (Note 2)

| DC Current Gain $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=5 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{Vdc}\right) \\ & \left(\mathrm{I}_{\mathrm{C}}=8 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{Vdc}\right) \end{aligned}$ | $\mathrm{h}_{\text {FE }}$ | 8 | - | 40 30 |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Collector-Emitter Saturation Voltage } \\ & \text { ( } \left.\mathrm{I}_{\mathrm{C}}=5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1 \mathrm{Adc}\right) \\ & \text { ( } \left.\mathrm{I}_{\mathrm{C}}=8 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.6 \mathrm{Adc}\right) \\ & \left(\mathrm{I}_{\mathrm{C}}=12 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=3 \mathrm{Adc}\right) \\ & \left(\mathrm{I}_{\mathrm{C}}=8 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.6 \mathrm{Adc}, \mathrm{~T}_{\mathrm{C}}=100^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{V}_{\text {CE(sat) }}$ |  | - | $\begin{gathered} 1 \\ 1.5 \\ 3 \\ 2 \end{gathered}$ | Vdc |
| $\begin{aligned} & \text { Base-Emitter Saturation Voltage } \\ & \text { ( } \left.I_{C}=5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1 \mathrm{Adc}\right) \\ & \left(I_{C}=8 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.6 \mathrm{Adc}\right) \\ & \left(I_{C}=8 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=1.6 \mathrm{Adc}, \mathrm{~T}_{\mathrm{C}}=100^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{V}_{\mathrm{BE} \text { (sat) }}$ | - | - | 1.2 1.6 1.5 | Vdc |

DYNAMIC CHARACTERISTICS

| Current-Gain - Bandwidth Product <br> $\left(\mathrm{I}_{\mathrm{C}}=500\right.$ mAdc, $\left.\mathrm{V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{f}=1 \mathrm{MHz}\right)$ | $\mathrm{f}_{\mathrm{T}}$ | 4 | - | - | MHz |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Capacitance <br> $\left(\mathrm{V}_{\mathrm{CB}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{E}}=0, \mathrm{f}=0.1 \mathrm{MHz}\right)$ | $\mathrm{C}_{\mathrm{ob}}$ | - | 180 | - | pF |

## SWITCHING CHARACTERISTICS

| Resistive Load (Table |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Delay Time | $\begin{aligned} & \left(\mathrm{V}_{\mathrm{CC}}=125 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=8 \mathrm{~A},\right. \\ & \mathrm{I}_{\mathrm{B} 1}=\mathrm{I}_{\mathrm{B} 2}=1.6 \mathrm{~A}, \mathrm{t}_{\mathrm{p}}=25 \mu \mathrm{~s}, \\ & \text { Duty Cycle } \leq 1 \%) \end{aligned}$ | $\mathrm{t}_{\mathrm{d}}$ | - | 0.06 | 0.1 | $\mu \mathrm{S}$ |
| Rise Time |  | $\mathrm{t}_{\mathrm{r}}$ | - | 0.45 | 1 | $\mu \mathrm{S}$ |
| Storage Time |  | $\mathrm{t}_{\text {s }}$ | - | 1.3 | 3 | $\mu \mathrm{s}$ |
| Fall Time |  | $\mathrm{t}_{\mathrm{f}}$ | - | 0.2 | 0.7 | $\mu \mathrm{S}$ |
| Inductive Load, Clamped (Table 1, Figure 13) |  |  |  |  |  |  |
| Voltage Storage Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=8 \mathrm{~A}, \mathrm{~V}_{\text {clamp }}=300 \mathrm{Vdc},\right. \\ & \left.\mathrm{I}_{\mathrm{B} 1}=1.6 \mathrm{~A}, \mathrm{~V}_{\mathrm{BE} \text { (off) })}=5 \mathrm{Vdc}, \mathrm{~T}_{\mathrm{C}}=100^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{t}_{\mathrm{sv}}$ | - | 0.92 | 2.3 | us |
| Crossover Time |  | $\mathrm{t}_{\mathrm{c}}$ | - | 0.12 | 0.7 | $\mu \mathrm{S}$ |

2. Pulse Test: Pulse Width $=300 \mu \mathrm{~s}$, Duty Cycle $=2 \%$.


Figure 1. Forward Bias Safe Operating Area


Figure 2. Reverse Bias Switching Safe Operating Area

The Safe Operating Area figures shown in Figures 1 and 2 are specified ratings for these devices under the test conditions shown.


Figure 3. Forward Bias Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{C}-V_{C E}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 1 is based on $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$; $\mathrm{T}_{\mathrm{J}(\mathrm{pk})}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to $10 \%$ but must be derated when $\mathrm{T}_{\mathrm{C}} \geq 25^{\circ} \mathrm{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 1 may be found at any case temperature by using the appropriate curve on Figure 3.
$\mathrm{T}_{\mathrm{J}(\mathrm{pk})}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. Use of reverse biased safe operating area data (Figure 2) is discussed in the applications information section.


Figure 4. Typical Thermal Response $\left[Z_{\theta J C}(t)\right]$

MJE13009


Figure 5. DC Current Gain


Figure 7. Base-Emitter Saturation Voltage


Figure 9. Collector Cutoff Region


Figure 6. Collector Saturation Region


Figure 8. Collector-Emitter Saturation Voltage


Figure 10. Capacitance

## MJE13009

Table 1. Test Conditions for Dynamic Performance

| REVERSE BIAS SAFE OPERATING AREA AND INDUCTIVE SWITCHING |  | RESISTIVE SWITCHING |
| :---: | :---: | :---: |
|  |  |  |
| $\begin{aligned} & \text { 들 } \\ & \text { 씅 } \end{aligned}$ | Coil Data: GAP for $200 \mu \mathrm{H} / 20 \mathrm{~A}$ $\mathrm{~V}_{\text {CC }}=20 \mathrm{~V}$ <br> Ferroxcube Core \#6656 $\mathrm{L}_{\text {coil }}=200 \mu \mathrm{H}$ $\mathrm{V}_{\text {clamp }}=300 \mathrm{Vdc}$ <br> Full Bobbin ( $\sim 16$ Turns) $\# 16$   | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=125 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{C}}=15 \Omega \\ & \mathrm{D} 1=1 \mathrm{~N} 5820 \text { or Equiv. } \\ & \mathrm{R}_{\mathrm{B}}=\Omega \end{aligned}$ |
|  | OUTPUT WAVEFORMS <br> $\mathrm{t}_{1}$ ADJUSTED TO OBTAIN IC <br> $\mathrm{t}_{1} \approx \frac{\mathrm{~L}_{\text {coil }}\left(I_{C M}\right)}{\mathrm{V}_{\mathrm{CC}}}$ <br> Test Equipment Scope-Tektronics 475 or Equivalent $\mathrm{t}_{2} \approx \frac{\mathrm{~L}_{\text {coil }}\left(\mathrm{I}_{\mathrm{CM}}\right)}{\mathrm{V}_{\text {clamp }}}$ | $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}<10 \mathrm{~ns}$ <br> Duty Cycle $=1.0 \%$ <br> $R_{B}$ and $R_{C}$ adjusted <br> for desired $\mathrm{I}_{\mathrm{B}}$ and $\mathrm{I}_{\mathrm{C}}$ |

## APPLICATIONS INFORMATION FOR SWITCHMODE SPECIFICATIONS

## INTRODUCTION

The primary considerations when selecting a power transistor for SWITCHMODE applications are voltage and current ratings, switching speed, and energy handling capability. In this section, these specifications will be discussed and related to the circuit examples illustrated in Table 2. (Note 3)

## VOLTAGE REQUIREMENTS

Both blocking voltage and sustaining voltage are important in SWITCHMODE applications.

Circuits B and C in Table 2 illustrate applications that require high blocking voltage capability. In both circuits the switching transistor is subjected to voltages substantially higher than $\mathrm{V}_{\mathrm{CC}}$ after the device is completely off (see load line diagrams at $\mathrm{I}_{\mathrm{C}}=\mathrm{I}_{\text {leakage }} \approx 0$ in Table 2). The blocking capability at this point depends on the base to emitter conditions and the device junction temperature. Since the highest device capability occurs when the base to emitter junction is reverse biased ( $\mathrm{V}_{\mathrm{CEV}}$ ), this is the recommended and specified use condition. Maximum $\mathrm{I}_{\mathrm{CEV}}$ at rated $\mathrm{V}_{\mathrm{CEV}}$ is specified at a relatively low reverse bias $(1.5 \mathrm{~V})$ both at $25^{\circ} \mathrm{C}$ and $100^{\circ} \mathrm{C}$. Increasing the reverse bias will give some improvement in device blocking capability.

The sustaining or active region voltage requirements in switching applications occur during turn-on and turn-off. If the load contains a significant capacitive component, high current and voltage can exist simultaneously during turn-on and the pulsed forward bias SOA curves (Figure 1) are the proper design limits.

For inductive loads, high voltage and current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as a Reverse Bias Safe Operating Area (Figure 2) which represents voltage-current conditions that can be sustained during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

In the four application examples (Table 2) load lines are shown in relation to the pulsed forward and reverse biased SOA curves.

In circuits $A$ and $D$, inductive reactance is clamped by the diodes shown. In circuits B and C the voltage is clamped by
the output rectifiers, however, the voltage induced in the primary leakage inductance is not clamped by these diodes and could be large enough to destroy the device. A snubber network or an additional clamp may be required to keep the turn-off load line within the Reverse Bias SOA curve.

Load lines that fall within the pulsed forward biased SOA curve during turn-on and within the reverse bias SOA curve during turn-off are considered safe, with the following assumptions:

1. The device thermal limitations are not exceeded.
2. The turn-on time does not exceed $10 \mu \mathrm{~s}$ (see standard pulsed forward SOA curves in Figure 1).
3. The base drive conditions are within the specified limits shown on the Reverse Bias SOA curve (Figure 2).

## CURRENT REQUIREMENTS

An efficient switching transistor must operate at the required current level with good fall time, high energy handling capability and low saturation voltage. On this data sheet, these parameters have been specified at 8 amperes which represents typical design conditions for these devices. The current drive requirements are usually dictated by the $\mathrm{V}_{\mathrm{CE}(\text { sat })}$ specification because the maximum saturation voltage is specified at a forced gain condition which must be duplicated or exceeded in the application to control the saturation voltage.

## SWITCHING REQUIREMENTS

In many switching applications, a major portion of the transistor power dissipation occurs during the fall time $\left(\mathrm{t}_{\mathrm{fi}}\right)$. For this reason considerable effort is usually devoted to reducing the fall time. The recommended way to accomplish this is to reverse bias the base-emitter junction during turn-off. The reverse biased switching characteristics for inductive loads are discussed in Figure 11 and Table 3 and resistive loads in Figures 13 and 14. Usually the inductive load component will be the dominant factor in SWITCHMODE applications and the inductive switching data will more closely represent the device performance in actual application. The inductive switching characteristics are derived from the same circuit used to specify the reverse biased SOA curves, (See Table 1) providing correlation between test procedures and actual use conditions.
3. For detailed information on specific switching applications, see ON Semiconductor Application Notes AN-719, AN-767.

RESISTIVE SWITCHING PERFORMANCE


Figure 11. Turn-On Time


Figure 13. Inductive Switching Measurements


Figure 12. Turn-Off Time


Figure 14. Typical Inductive Switching Waveforms (at 300 V and 12 A with $\mathrm{I}_{\mathrm{B} 1}=2.4 \mathrm{~A}$ and $\mathrm{V}_{\mathrm{BE}}$ (off) $=5 \mathrm{~V}$ )

## MJE13009

Table 2. Applications Examples of Switching Circuits

| CIRCUIT | LOAD LINE DIAGRAMS | TIME DIAGRAMS |
| :---: | :---: | :---: |
| SERIES SWITCHING REGULATOR |  |  |
| RINGING CHOKE INVERTER |  |  |
| PUSH-PULL INVERTER/CONVERTER |  |  |
| SOLENOID DRIVER |  |  |

## MJE13009

Table 3. Typical Inductive Switching Performance

| $\mathbf{I}_{\mathbf{c}}$ <br> $\mathbf{A M P}$ | $\mathbf{T}_{\mathbf{c}}$ <br> ${ }^{\circ} \mathbf{C}$ | $\mathbf{t}_{\mathbf{s v}}$ <br> $\mathbf{n s}$ | $\mathbf{t}_{\mathbf{r v}}$ <br> $\mathbf{n s}$ | $\mathbf{t}_{\mathbf{f i}}$ <br> $\mathbf{n s}$ | $\mathbf{t}_{\mathbf{t i}}$ <br> $\mathbf{n s}$ | $\mathbf{t}_{\mathbf{c}}$ <br> $\mathbf{n s}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 3 | 25 | 770 | 100 | 150 | 200 | 240 |
|  | 100 | 1000 | 230 | 160 | 200 | 320 |
| 5 | 25 | 630 | 72 | 26 | 10 | 100 |
|  | 100 | 820 | 100 | 55 | 30 | 180 |
| 8 | 25 | 720 | 55 | 27 | 2 | 77 |
|  | 100 | 920 | 70 | 50 | 8 | 120 |
| 12 | 25 | 640 | 20 | 17 | 2 | 41 |
|  | 100 | 800 | 32 | 24 | 4 | 54 |

NOTE: All Data recorded In the Inductive Switching Circuit In Table 1.

## SWITCHING TIME NOTES

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.
$\mathrm{t}_{\mathrm{sv}}=$ Voltage Storage Time, $90 \% \mathrm{I}_{\mathrm{B} 1}$ to $10 \% \mathrm{~V}_{\mathrm{CEM}}$
$\mathrm{t}_{\mathrm{rv}}=$ Voltage Rise Time, $10-90 \% \mathrm{~V}_{\mathrm{CEM}}$
$\mathrm{t}_{\mathrm{fi}}=$ Current Fall Time, $90-10 \% \mathrm{I}_{\mathrm{CM}}$
$\mathrm{t}_{\mathrm{ti}}=$ Current Tail, $10-2 \% \mathrm{I}_{\mathrm{CM}}$
$\mathrm{t}_{\mathrm{c}}=$ Crossover Time, $10 \% \mathrm{~V}_{\mathrm{CEM}}$ to $10 \% \mathrm{I}_{\mathrm{CM}}$
An enlarged portion of the turn-off waveforms is shown in Figure 13 to aid in the visual identity of these terms.

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN222/D:

$$
P_{S W T}=1 / 2 \mathrm{~V}_{\mathrm{CC}} \mathrm{l}_{\mathrm{C}}\left(\mathrm{t}_{\mathrm{c}}\right) f
$$

Typical inductive switching waveforms are shown in Figure 14. In general, $\mathrm{t}_{\mathrm{rv}}+\mathrm{t}_{\mathrm{fi}} \simeq \mathrm{t}_{\mathrm{c}}$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at $25^{\circ} \mathrm{C}$ and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a "SWITCHMODE" transistor are the inductive switching speeds ( $\mathrm{t}_{\mathrm{c}}$ and $\mathrm{t}_{\mathrm{sv}}$ ) which are guaranteed at $100^{\circ} \mathrm{C}$.

## MJE13009

## PACKAGE DIMENSIONS

TO-220AB
CASE 221A-09
ISSUE AA


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | ---: | ---: | ---: | ---: |
|  | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.405 | 9.66 | 10.28 |
| C | 0.160 | 0.190 | 4.07 | 4.82 |
| D | 0.025 | 0.035 | 0.64 | 0.88 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.155 | 2.80 | 3.93 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

SWITCHMODE is a trademark of Semiconductor Components Industries, LLC.
ON Semiconductor and 0 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications
 and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

## LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082-1312 USA

Phone: 480-829-7710 or 800-344-3860 Toll Free USA/Canada Fax: 480-829-7709 or 800-344-3867 Toll Free USA/Canada Email: orderli@@onsemi.com
N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051 Phone: 81-3-5773-3850

ON Semiconductor Website: http://onsemi.com Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.

